

500mA Single Chip Li-Ion and Li-Polymer Charger

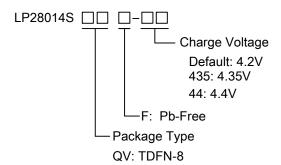
General Description

The LP28014S is a complete constant-current/ constant voltage linear charger for single cell lithium-ion battery. Its TDFN-8 package and low external component count make the LP28014S ideally suited for portable applications. No external sense resistor is needed, and no blocking diode is required due to the internal MOSFET architecture. Thermal feedback regulates the charge current to limit the die temperature during high power operation or high ambient temperature. The charge voltage is fixed at 4.2V, and the charge current can be ISET programmed externally with a single resistor.

When the input supply is removed, the LP28014S automatically enters a low current state, dropping the battery drain current to less than < $1\mu A$.

Other features include charge current monitor, under voltage lockout, automatic recharge and a status pin to indicate charge termination and the presence of an input voltage.

Order Information



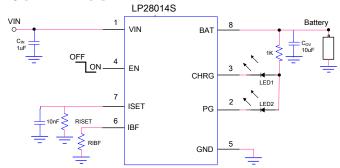
Applications

- ♦ Portable Media Players/Game
- ♦ Power Bank
- Bluetooth Applications
- ♦ PDA/MID

Features

- input voltage up to 28V
- ♦ input Over Voltage Protection: 7V
- ◆ Short-circuit protection
- Programmable Charge Current: 50mA to 500mA
- ♦ < 1µA Battery Reverse Current
 </p>
- Protection of Reverse Connection of Battery
- ◆ No MOSFET, Sense Resistor or Blocking Diode Required
- Constant-Current/Constant-Voltage Operation with Thermal Regulation to Maximize Charge Rate Without Risk of Overheating
- ◆ TDFN-8 2mmx2mm Package
- RoHS Compliant and 100% Lead (Pb)-Free

Typical Application Circuit



Marking Information

Device	Marking	Package	Shipping	
	LPS			
LP28014SQVF	P28014	TDFN-8	4K/REEL	
	42YWX			
	LPS			
LP28014SQVF-435	P28014	TDFN-8	4K/REEL	
	435WX			
	LPS			
LP28014SQVF-44	P28014	TDFN-8	4K/REEL	
	44YWX			
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Marking indication:

Y:Production year W:Production week X: Series Number



Functional Pin Description

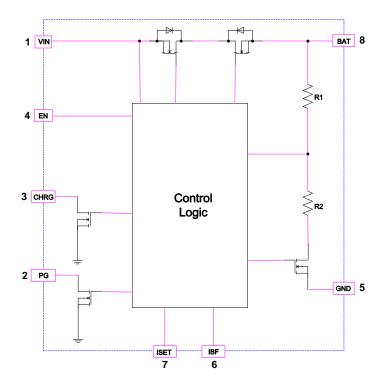
Package Type	Pin Configurations		
TDFN-8	VIN 1 PG 2 CHRG 3 EN 4 BAT 7 ISET Exposed Pad 6 IBF 5 GND		

Pin Description

PIN No.	PIN NAME	DESCRIPTION
1	VIN	VIN is the input power source. Connect to a wall adapter.
2	PG	Open-Drain Status Output. Low indicates the input voltage is above UVLO and the OUT (battery) voltage.
3	CHRG	Open-Drain Charge Status Output. When the battery is charging, the CHRG pin is pulled low by an internal NMOS. When the charge cycle is completed, the pin could be pulled High by an external pull high resistor.
4	EN	Charge Enable Input (active low).
5	GND	GND is the connection to system ground.
6	IBF	Charge Status Threshold Program. Connect this pin to an external resistor to program the charge termination current.
7	ISET	Charge Current Program. The charge current is programmed by connecting a 1% resistor(R _{ISET}) to ground.
8	BAT	BAT is the connection to the battery. Typically a 10µF Tantalum capacitor is needed for stability when there is no battery attached. When a battery is attached, only a 1µF ceramic capacitor is required.

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Function Block Diagram



Absolute Maximum Ratings Note 1

	Input Voltage to GND	0.3V to 28V
	BAT voltage GND	5V to 6.5V
	Other pin to GND	0.3V to 6.5V
	Output current	1200mA
	Maximum Junction Temperature	125°C
	Maximum Soldering Temperature (at leads, 10 sec)	260°C
	Storage Temperature	55°C to 150°C
Th	ermal Information	
\diamond	Thermal Resistance (θ _{JA})	76°C/W

ESD Susceptibility

- HBM(Human Body Mode) ------ 2KV

Note 1. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Recommended Operating Conditions

- Input supply voltage ----- 4.5V to 6.5V
- Operating Ambient Temperature Range-----

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Electrical Characteristics

(T_A = 25°C. V_{IN} = 5V, unless otherwise noted.)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNITS
I _{IN}	Input Supply Current			50		uA
V _{EN_ON}	EN Logic-Low Voltage Threshold				0.4	V
V _{EN_OFF}	EN Logic-High Voltage Threshold		1.4			V
		LP28014SQVF	4.158	4.2	4.242	V
V _{FLOAT}	Regulated Output (Float) Voltage	LP28014SQVF-435		4.35		V
		LP28014SQVF-44		4.4		V
Vuv	V _{IN} Under voltage Lockout Threshold	From V _{IN} Low to High		3.3		V
Vuvhys	V _{IN} Under voltage Lockout Hysteresis			150		mV
Vove	Input Voltage OVP	V _{IN} Rising	6.7	7	7.3	V
V _{OVP-HYS}	OVP Hysteresis			0.2		V
	BAT Pin Current	R _{ISET} = 10k, Current Mode		130		mA
I _{BAT}		R _{ISET} = 4k, Current Mode		325		mA
		V _{BAT} = 4.2V, Vin=float		1		uA
Itrikl	Trickle Charge Current	$V_{BAT} < V_{TRIKL}$, Current Mode		10		%Іват
V _{TRIKL}	Trickle Charge Threshold Voltage	V _{BAT} Rising		2.6		V
VTRHYS	Trickle Charge Hysteresis Voltage			150		mV
I _{BF}	Battery Full Programming Range		10		50	%I _{BAT}
Viset	ISET Pin Voltage	R _{ISET} = 10k, Current Mode		1		V
ISTAT	CHRG/PG Pin Weak Pull-Down Current	V _{STAT} = 5V			5	uA
VSTAT	CHRG Pin Output Low Voltage	I _{STAT} = 5mA			0.5	V
ΔV_{RESTAT}	Recharge Battery Threshold Voltage	V _{FLOAT} - V _{RESTAT}		150		mV
T _{LIM}	Junction Temperature in Thermal Protection			125		°C

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Application Information

Input Voltage Range

The LP28014S has built-in input voltage surge protection as high as +28V. The charger IC will be automatically disabled when the input voltage is lower than 3.3V or higher than 7.0V. The open-drain PG Pin is used to indicate an input power good condition (3.3V<VIN<6.7V). If the input voltage is lower than the battery voltage, the IC is also disabled to prevent the battery from draining.

A charge cycle begins when the voltage at the VIN pin rises above the UVLO threshold level, when a battery is connected to the charger output. If the BAT pin is less than 2.6V, the charger enters trickle charge mode. In this mode, the LP28014S supplies approximately 1/10 programmed charge current to bring the battery voltage up to a safe level for full current charging. When the BAT pin voltage rises above 2.6V, the charger enters constant-current mode(CC), where the ISET programmed charge current is supplied to the battery. When the BAT pin approaches the final float voltage, the LP28014S enters constant-voltage mode(CV) and the charge current begins to decrease, and the battery full indication is set when the charge current in the CV mode is reduced to the programmed full battery current (IBF).

ISET programming Charge Current

The charge current (I_{BAT}) is set by a resistor (R_{ISET}) connecting from the ISET pin to GND. The relationship of the charge current and the programming resistance is established by the following table.

 $I_{BAT}(mA) = V_{ISET} \times 1300 / R_{ISET}(K\Omega)$

Termination charge current programmed

The battery charge Termination current threshold (IBF) is programmed by connecting a resistor RBF from the IBF pin to GND:

 $I_{BF} = R_{ISET} \times I_{BAT} / R_{IBF}$

Automatic Recharge

Once the charge cycle is terminated, the LP28014S continuously monitors the voltage on the BAT pin. A charge cycle restarts when the battery voltage falls below 4.05V (which corresponds to approximately 80% to 90% battery capacity). This ensures that the battery is kept at or near a fully charged condition and eliminates the need for periodic charge cycle initiations.

Enable Function

The LP28014S features an enable/disable function. An input "Low" signal at EN pin or if this pin is floating will enable the IC. To assure the charger will switch on, the EN turn on control level must below 0.4 volts. The charger IC r will go into the shutdown mode when the voltage on the EN pin is greater than 1.4 volts. If the enable function is not needed in a specific application, it may be tied to GND or floating to keep the charge IC in a continuously on state.

Thermal Limiting

An internal thermal feedback loop reduces the I SET rammed charge current if the die temperature attempts to rise above a preset value of approximately 125°C. This feature protects the LP28014S from excessive temperature and allows the user to push the limits of the power handling capability of a given circuit board without risk of damaging the LP28014S. The charge current can be set according to typical (not Worst-case) ambient temperature with the assurance that the charger will automatically reduce the current in worst-case conditions.

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Charge Status Indicator (CHAG & PG)

After application of a 5V source, the input voltage rises above the U_{VLO} and sleep thresholds (V_{IN} > V_{BAT} + V_{DT}),but is less than OVP (V_{IN} < V_{OVP}), then the PG turns on and provides a low impedance path to ground.

CHRG has two different states: strong pull-down (~5mA) and high impedance. The strong pull-down state indicates that the LP28014SA is in a charge cycle. When the charger is entered CV mode and Once the charge current has reduced to the battery full charge current threshold (IBF), the CHRG pin will become high impedance.

Function	CHRG
Charging	Low
Charge END	High

Function	PG
VIN <uvlo< td=""><td>High</td></uvlo<>	High
UVLO <vin<ovp< td=""><td>Low</td></vin<ovp<>	Low
OVP <vin< td=""><td>High</td></vin<>	High

Power Dissipation

The conditions that cause the LP28014S to reduce charge current through thermal feedback can be approximated by considering the power dissipated in the IC. Nearly all of this power dissipation is generated by the internal MOSFET calculated to be approximately:

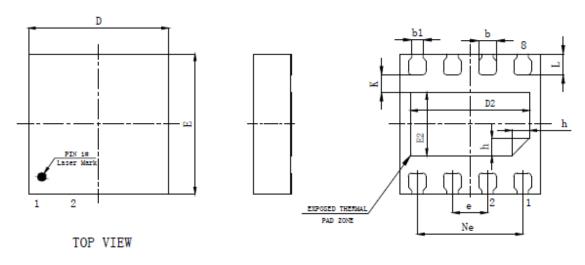
$$P_D = (V_{IN} - V_{BAT}) \cdot I_{BAT}$$

where PD is the power dissipated, VIN is the input supply voltage, VBAT is the battery voltage and IBAT is the charge current. The approximate ambient temperature at which the thermal feedback begins to protect the IC is:

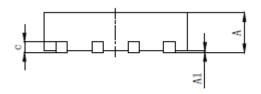
 $T_A=125^{\circ}C-PD \cdot \theta_{JA}$

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Packaging Information



BOTTOM VIEW



SIDE VIEW

CMMDOL	MILLIMETER		
SYMBOL	MIN	NOM	MAX
A	0.50	0.55	0.60
A1	0	0.02	0.05
b	0.20	0.25	0.30
b1	0.11	0.16	0.21
С	0.10	0.15	0.20
D	1.90	2.00	2.10
D2	1.60	1.70	1.80
e	0.50BSC		
Ne	1.50BSC		
Е	1.90	2.00	2.10
E2	0.80	0.90	1.00
L	0.25	0.30	0.35
h	0.20	0.25	0.30
K	0.20	0.25	0.30

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